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Vishay General Semiconductor

Standard Avalanche SMD Rectifier



DO-214AC (SMA)

1.5 A

200 V, 400 V, 600 V, 800 V,

1000 V, 1600 V

30 A

1.0 µA

1.15 V

20 mJ

150 °C

DO-214AC (SMA)

Single die

PRIMARY CHARACTERISTICS

 $I_{F(AV)}$

V_{RRM}

IFSM

 I_R

 V_{F}

E_R

T_J max.

Package

Diode variations

FEATURES

- Low profile package
- Ideal for automated placement
- Controlled avalanche characteristics
- · Glass passivated pallet chip junction
- Low reverse current
- High surge current capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 gualified
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Note

BYG10Y for commercial grade only

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)									
PARAMETER	SYMBOL	BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	UNIT	
Device marking code		BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y		
Maximum repetitive peak reverse voltage	V _{RRM}	V _{RRM} 200 400 600 800 1000				1600	V		
Average forward current	I _{F(AV)}	1.5							
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30						А	
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1 A, T_J = 25 \degree C$ (for BYG10D thru BYG10M) $I_{(BR)R} = 0.4 A, T_J = 25 \degree C$ (for BYG10Y)	E _R	20						mJ	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150						°C	

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ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)										
PARAMETER	TEST CONDITIONS		SYMBOL	BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	UNIT
Maximum instantaneous	I _F = 1 A	T _{.1} = 25 °C V _F				1.1				v
forward voltage ⁽¹⁾	I _F = 1.5 A	1j = 25 0	25 °C V _F		1.15					
Maximum DC reverse	$\mathcal{M} = \mathcal{M}$	$T_{\rm J} = 25 ^{\circ}{\rm C}$								
current	$V_{R} = V_{RRM}$	T _J = 100 °C	I _R	10					μA	
Maximum reverse recovery time	I _F = 0.5 A, I _F I _{rr} = 0.25 A	= 1.0 A, t _{rr}		4						μs

Note

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)									
PARAMETER	SYMBOL	OL BYG10D BYG10G BYG10J BYG10K BYG10M BYG				BYG10Y	UNIT		
Typical thermal resistance, junction to lead	$R_{\theta JL}$	25						°C/W	
	R _{0JA} ⁽¹⁾	150						°C/W	
Typical thermal resistance, junction to ambient	R _{0JA} ⁽²⁾	125							
	R _{0JA} ⁽³⁾	100							

Notes

⁽¹⁾ Mounted on epoxy-glass hard tissue

⁽²⁾ Mounted on epoxy-glass hard tissue, 50 mm² 35 µm Cu

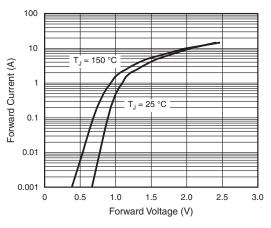
(3) Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 µm Cu

ORDERING INFORMATION (Example)									
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE					
BYG10D-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel					
BYG10D-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel					
BYG10DHM3/TR ⁽¹⁾	0.064	TR	1800	7" diameter plastic tape and reel					
BYG10DHM3/TR3 ⁽¹⁾	0.064	TR3	7500	13" diameter plastic tape and reel					

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)





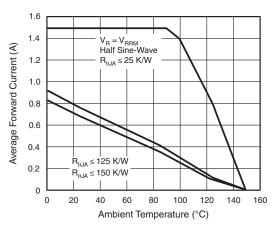


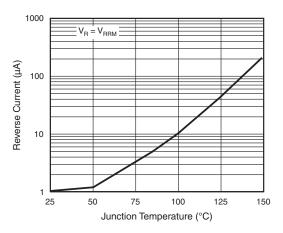
Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

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Fig. 3 - Reverse Current vs. Junction Temperature

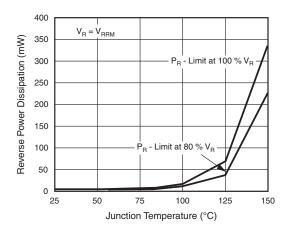


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

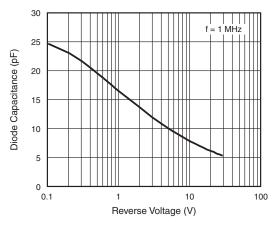


Fig. 5 - Diode Capacitance vs. Reverse Voltage

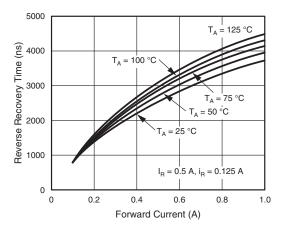


Fig. 6 - Reverse Recovery Time vs. Forward Current

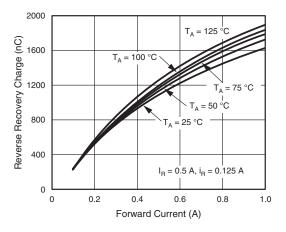


Fig. 7 - Reverse Recovery Charge vs. Forward Current

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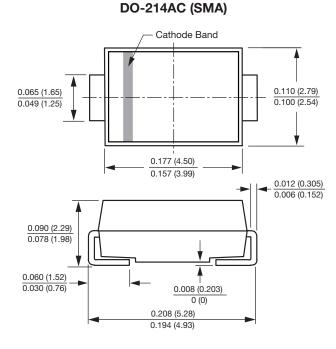
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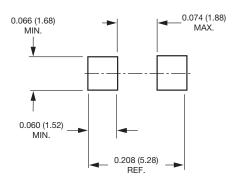
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

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Mounting Pad Layout

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